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| LIST OF PUBLICATIONS CITED BY APPLICANT | <u>Attorney Docket No.</u> SEL 237 | <u>Serial No.</u> Not Assigned |
| | <u>Applicant</u> Mitsuaki OSAME et al | |
| | <u>Filing Date</u> Herewith | <u>Group</u> |

JP971 U.S. Pat.
09/772725
01/30/01

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| *EXAMINER INITIAL | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB- CLASS | FILING DATE |
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| RLO | JP 7-130652 | 05/19/95 | Semiconductor Energy Laboratory Co., Ltd. | | | 10/29/93 |
| RLO | JP 8-078329 | 03/22/96 | Semiconductor Energy Laboratory Co., Ltd. | | | 09/05/94 |
| RLO | JP 10-135468 | 05/22/98 | Semiconductor Energy Laboratory Co., Ltd. | | | 10/24/96 |
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| RLO | 1) English abstract re Japanese patent application no. 7-130652, published May 19, 1995. |
| RLO | 2) English abstract re Japanese patent application no. 8-078329, published March 22, 1996. |
| RLO | 3) English abstract re Japanese patent application no. 10-135468, published May 22, 1998. |
| RLO | 4) English abstract re Japanese patent application no. 10-135469, published May 22, 1998. |

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| EXAMINER: <i>Tina De Rosa</i> | DATE CONSIDERED: 7/3/2003 |
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*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.